



## CR200F-10-02-B3-EX

## 200mm Wafer Carrier

Pozzetta will protect your valuable products from particles, ESD damage, outgassed components, and high costs. Companies around the world trust Pozzetta to create secure environments for the semiconductor, electronics, and medical industries.

Dimensions	Features and Benefits	CR200F-10-02-B3-EX
<p>Capacity: 13</p> <p>Overall Size: 235mm x 209mm x 219mm</p> <p>D<sub>1</sub> Dimension – distance from the H-shaped end surface to the center line of the first pocket (SEMI Std): 28.58mm</p> <p>Pocket Spacing – The distance between pocket center lines: 12.7mm</p> <p>Pocket Flat – The width of the pocket at its narrowest distance: 8.75mm</p>	<ul style="list-style-type: none"> <li>• H-shaped end for equipment interface</li> <li>• Card holder on solid end wall</li> <li>• Wash slots on bottom half of side walls</li> <li>• Wide pocket spacing for thick wafers. Can hold round substrates.</li> </ul> <p><b>Material Description</b></p> <p>BISHOP-3 is a conductive high performance resin that provides excellent heat resistance for long periods, chemical resistance and dimensional stability. Extremely low outgassing.</p>	